

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











Spec No. :DS22-2006-062 Effective Date: 03/16/2017

Revision: B

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4



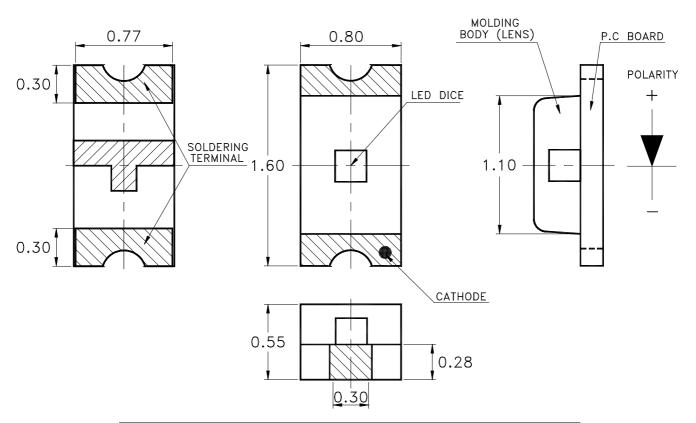
Property of Lite-On Only

Features

- * Meet RoHS, Green Product.
- * Super thin (0.55H mm) Chip LED.
- * Ultra bright InGaN White Chip LED.
- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic placement equipment.
- * Compatible with infrared reflow solder process.
- * EIA STD package.
- * I.C. compatible.

Package Dimensions





Part No.	Lens	Emitted Color
LTW-C191DS5	Yellow	InGaN White

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.10 mm (.004") unless otherwise noted.

Part No.: LTW-C191DS5	Page:	1	of	11		
-----------------------	-------	---	----	----	--	--



LITEON TECHNOLOGY CORPORATION

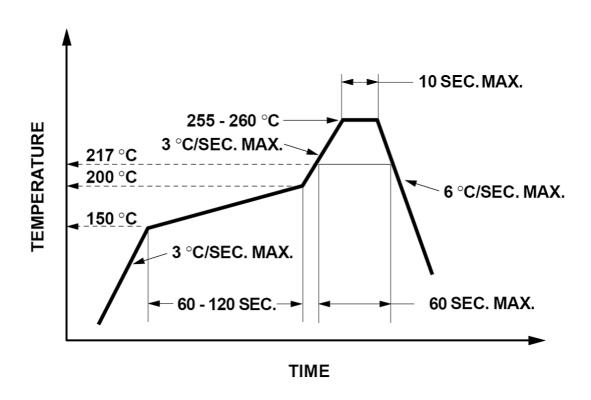
Property of Lite-On Only

Absolute Maximum Ratings At Ta=25℃

Parameter	LTW-C191DS5	Unit	
Power Dissipation	72	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA	
DC Forward Current	20	mA	
Reverse Voltage	5	V	
Operating Temperature Range	-30°C to + 85°C		
Storage Temperature Range	-55°C to + 105°C		
Infrared Soldering Condition	260°C For 10 Seconds		

Note: Reverse Voltage can't be continued operating.

Suggest IR Reflow Condition:



of Part No.: LTW-C191DS5 Page: 2 11



LITEON TECHNOLOGY CORPORATION

Property of Lite-On Only

Electrical Optical Characteristics At Ta=25°C

Parameter	Symbol	Part No. LTW-	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV	C191DS5	71.0		180.0	mcd	IF = 5mA Note 1, 2, 5
Viewing Angle	2 θ 1/2	C191DS5		130		deg	Fig.6
Chromaticity Coordinates	X	C191DS5		0.304			IF = 5mA Note 3, 5
Chromaticity Coordinates	у	C191D33		0.301			Fig.1
Forward Voltage	VF	C191DS5	2.70		3.15	V	IF = 5mA
Reverse Current	IR	C191DS5			10	μΑ	VR = 5V

Note: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2. Iv classification code is marked on each packing bag.
- 3. The chromaticity coordinates (x, y) is derived from the 1931 CIE chromaticity diagram.
- 4. Caution in ESD:

Static Electricity and surge damages the LED. It is recommend to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

5. Tester

CAS140B is for the chromaticity coordinates (x, y) and Iv.

6. The chromaticity coordinates (x, y) guarantee should be added ± 0.01 tolerance.

Part No.: LTW-C191DS5 Page: 3 of 11



Property of Lite-On Only

Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

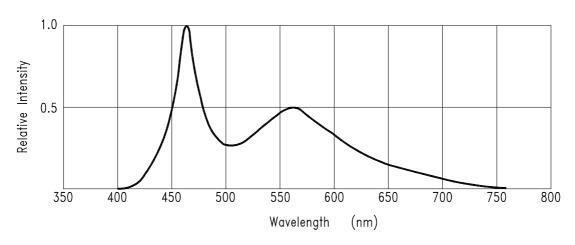
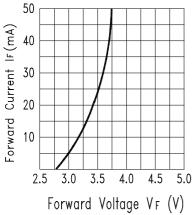


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH



Forward Voltage V_F (V) Fig.2 Forward Current vs. Forward Voltage

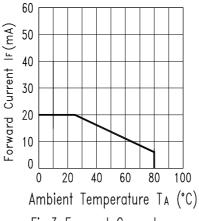


Fig.3 Forward Current
Derating Curve

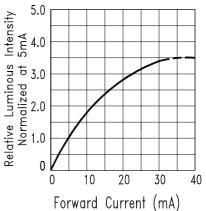


Fig.4 Relative Luminous Intensity
vs. Forward Current

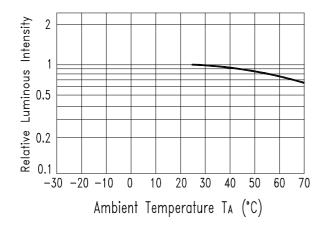


Fig.5 Luminous Intensity vs.

Ambient Temperature

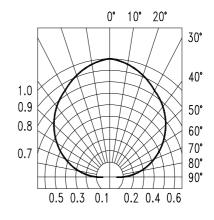


Fig.6 Spatial Distribution

of

11

Part No.: LTW-C191DS5 Page: 4



Property of Lite-On Only

Bin Code List

VF Spec. Table

VF Bin	Forward Voltage (V) at IF = 5mA		
VI DIII	Min.	Max.	
A	2.70	2.85	
В	2.85	3.00	
С	3.00	3.15	

Tolerance on each Forward Voltage bin is +/-0.1 volt

IV Spec. Table

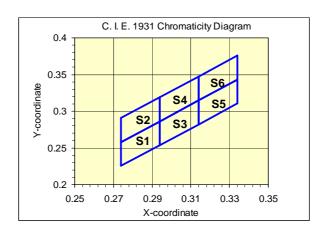
IV Bin	Luminous Intensity (mcd) at IF = 5mA			
I V DIII	Min.	Max.		
Q	71.0	112.0		
R	112.0	180.0		

Tolerance on each Luminous Intensity bin is +/- 15%.

Hue Spec. Table

Hue Bin	Color bin limits at IF = 5mA					
nue biii		CIE 1931CI	nromaticity	coordinates	S	
S1	X	0.274	0.274	0.294	0.294	
31	у	0.226	0.258	0.286	0.254	
S2	X	0.274	0.274	0.294	0.294	
32	у	0.258	0.291	0.319	0.286	
S 3	X	0.294	0.294	0.314	0.314	
33	у	0.254	0.286	0.315	0.282	
S4	X	0.294	0.294	0.314	0.314	
34	у	0.286	0.319	0.347	0.315	
95	X	0.314	0.314	0.334	0.334	
S5	у	0.282	0.315	0.343	0.311	
S6	X	0.314	0.314	0.334	0.334	
30	у	0.315	0.347	0.376	0.343	

Tolerance on each Hue (x, y) bin is ± -0.01 .



Part No.: LTW-C191DS5 Page: 5 of 11



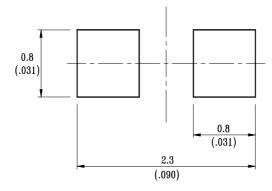
Property of Lite-On Only

Cleaning

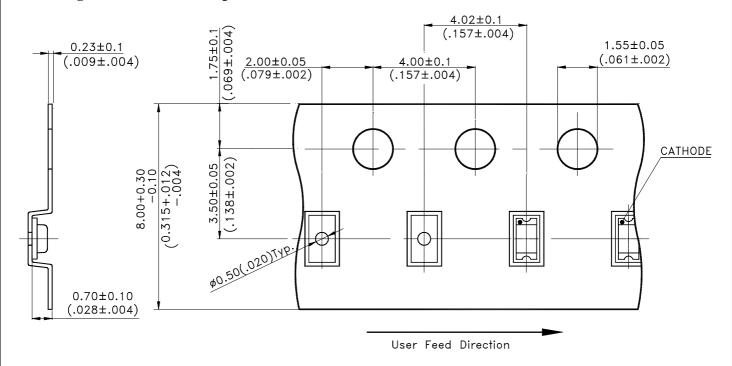
Do not use unspecified chemical liquid to clean LED they could harm the package.

If clean is necessary, immerse the LED in ethyl alcohol or in isopropyl alcohol at normal temperature for less one minute.

Suggest Soldering Pad Dimensions



Package Dimensions Of Tape And Reel



Notes:

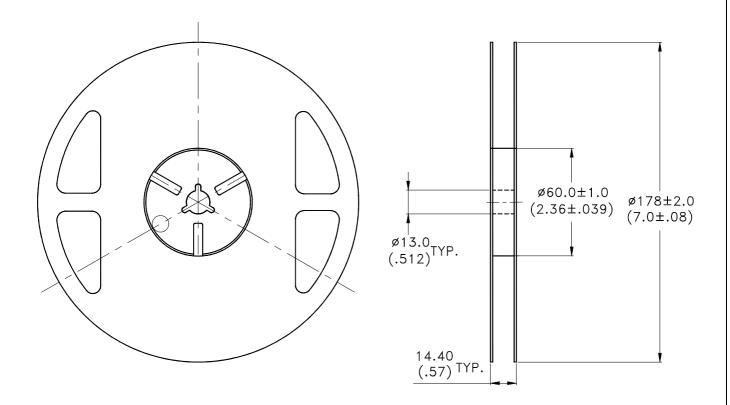
1. All dimensions are in millimeters (inches).

Part No.: LTW-C191DS5	Page:	6	of	11		
-----------------------	-------	---	----	----	--	--



Property of Lite-On Only

Package Dimensions of Reel



Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel-5000 pieces per reel.
- 3. Minimum packing quantity is 500 pieces for remainders.
- 4. The maximum number of consecutive missing lamps is two.
- 5. In accordance with ANSI/EIA 481-1-A-1994 specifications.

of Part No.: LTW-C191DS5 Page: 11



Property of Lite-On Only

CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The package is sealed:

The LEDs should be stored at 30°C or less and 90%RH or less. And the LEDs are limited to use within one year, while the LEDs is packed in moisture-proof package with the desiccants inside.

The package is opened:

The storage ambient for the LEDs should not exceed 30°C temperature or 60% relative humidity.

It is recommended that LEDs out of their original packaging are IR-reflowed within 672hrs

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant, or in a desiccators with nitrogen ambient.

LEDs stored out of their original packaging for more than one week should be baked at about 60 deg C for at least 20 hours before solder assembly.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

4. Soldering

Recommended soldering conditions:

Reflo	w soldering	Soldering iron		
Pre-heat Pre-heat time Peak temperature Soldering time	150~200°C 120 sec. Max. 260°C Max. 10 sec. Max.(Max. two times)	Soldering time	300°C Max. 3 sec. Max. (one time only)	

Soldering notes:

Because different board designs use different number and types of devices, solder pastes, reflow ovens, and circuit boards, no single temperature profile works for all possible combinations.

However, you can successfully mount your packages to the PCB by following the proper guidelines and PCB-specific characterization.

LITE-ON Runs both component-level verification using in-house KYRAMX98 reflow chambers and board-level assembly.

The results of this testing are verified through post-reflow reliability testing.

Profiles used at LITE-ON are based on JEDEC standards to ensure that all packages can be successfully and reliably surface mounted.

Figure on page3 shows a sample temperature profile compliant to JEDEC standards.

You can use this example as a generic target to set up your reflow process.

You should adhere to the JEDEC profile limits as well as specifications and recommendations from the solder paste manufacturer to avoid damaging the device and create a reliable solder joint.

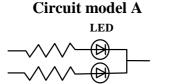


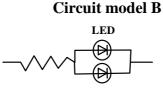
LITEON TECHNOLOGY CORPORATION

Property of Lite-On Only

5. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.





- (A) Recommended circuit.
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

6. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no lightup" at low currents.

To verify for ESD damage, check for "lightup" and Vf of the suspect LEDs at low currents.

The Vf of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.

Part No.: LTW-C191DS5 Page: 9 of 11



Property of Lite-On Only

7. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 500HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS C 7021:B-1
Endurance Test	High Temperature High Humidity Storage	Ta= 65±5°C,RH= 90∼95% *Test Time= 240HRS±2HRS	MIL-STD-202F:103B JIS C 7021:B-11
	High Temperature Storage	Ta= 105±5°C *Test Time= 500HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 JIS C 7021:B-10
	Low Temperature Storage	Ta= -55±5°C *Test Time=500HRS (-24HRS,+72H RS)	JIS C 7021:B-12
	Temperature Cycling	105° C ~ 25° C ~ -55° C ~ 25° C 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS C 7021:A-4
	Thermal Shock	$85 \pm 5^{\circ}$ C $\sim -40^{\circ}$ C $\pm 5^{\circ}$ C 10mins 10mins 10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1011
T	Solder Resistance	T.sol= $260 \pm 5^{\circ}$ C Dwell Time= 10 ± 1 secs	MIL-STD-202F:210A MIL-STD-750D:2031 JIS C 7021:A-1
Environmental Test	IR-Reflow	Ramp-up rate(217°C to Peak) +3°C/ second max Temp. maintain at 175(±25)°C 180 seconds max Temp. maintain above 217°C 60-150 seconds Peak temperature range 260°C+0/-5°C Time within 5°C of actual Peak Temperature (tp) 10-30 seconds Ramp-down rate +6°C/second max	MIL-STD-750D:2031.2 J-STD-020D
	Solderability	T.sol= 235 ± 5 °C Immersion time 2 ± 0.5 sec Immersion rate 25 ± 2.5 mm/sec Coverage ≥95% of the dipped surface	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 IEC 68 Part 2-20 JIS C 7021:A-2

8. Others

The appearance and specifications of the product may be modified for improvement without prior notice.

Part No.: LTW-C191DS5 Page: 10 of 11



Property of Lite-On Only

9. Suggested Checking List

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wears wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycles?

Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

Part No.: LTW-C191DS5 Page: 11 of 11